## **3.3 V Dual Differential LVPECL/LVDS to LVTTL Translator**

# NB100ELT23L

#### Description

The NB100ELT23L is a dual differential LVPECL/LVDS to LVTTL translator. Because LVPECL (Positive ECL) or LVDS levels are used, only +3.3 V and ground are required. The small outline 8-lead package and the dual gate design of the ELT23L makes it ideal for applications which require the translation of a clock and a data signal.

The ELT23L is available in only the ECL 100K standard. Since there are no LVPECL outputs or an external  $V_{BB}$  reference, the ELT23L does not require both ECL standard versions. The LVPECL inputs are differential. Therefore, the NB100ELT23L can accept any standard differential LVPECL/LVDS input referenced from a  $V_{CC}$  of +3.3 V.

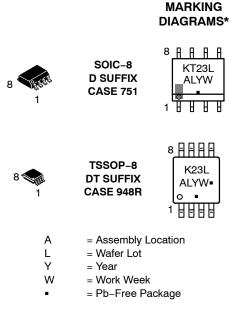
### Features

- 2.1 ns Typical Propagation Delay
- Maximum Operating Frequency > 160 MHz
- 24 mA LVTTL Outputs
- Operating Range:  $V_{CC} = 3.0 \text{ V}$  to 3.6 V with GND = 0 V
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant



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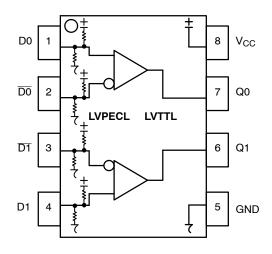
(Note: Microdot may be in either location)

\*For additional marking information, refer to Application Note <u>AND8002/D</u>.

### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NB100ELT23LDR2G	SOIC-8 (Pb-Free)	2500 / Tape & Reel
NB100ELT23LDTG	TSSOP-8 (Pb-Free)	100 Units / Tube
NB100ELT23LDTR2G	TSSOP-8 (Pb-Free)	2500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, <u>BRD8011/D</u>.



#### Figure 1. 8–Lead Pinout (Top View) and Logic Diagram

#### Table 1. PIN DESCRIPTION

PIN	FUNCTION
Q0, Q1	LVTTL Outputs
D0*, D1* D0**, D1**	Differential LVPECL Inputs
V <sub>CC</sub>	Positive Supply
GND	Ground

\*Pins will default to  $V_{CC}/2$  when left open. If connected to a common termination voltage under no signal conditions, then the device will be susceptible to self-oscillation.

\*\*Pins will default to 2/3 V<sub>CC</sub> when left open. If connected to a common termination voltage under no signal conditions, then the device will be susceptible to self-oscillation. See AND8020, Section 6 for options.

#### Table 2. ATTRIBUTES

Characteristics	Value
Internal Input Pulldown Resistor D D	50 kΩ 75 kΩ
Internal Input Pullup Resistor	50 kΩ
ESD Protection Human Body Model Machine Model Charged Device Model	> 1.5 kV > 100 V > 2 kV
Moisture Sensitivity, Indefinite Time Out of Drypack (Note 1)	Pb-Free Pkg
SOIC-8 TSSOP-8	Level 1 Level 3
Flammability Rating Oxygen Index: 28 to 34	UL 94 V-0 @ 1.25 in
Transistor Count	91 Devices
Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test	

1. For additional information, see Application Note AND8003/D.

#### **Table 3. MAXIMUM RATINGS**

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V <sub>CC</sub>	Power Supply	GND = 0 V		3.8	V
VI	Input Voltage	GND = 0 V	$V_I \leq V_{CC}$	3.8	V
l <sub>out</sub>	Output Current	Continuous Surge		50 100	mA mA
T <sub>A</sub>	Operating Temperature Range			-40 to +85	°C
T <sub>stg</sub>	Storage Temperature Range			-65 to +150	°C
$\theta_{JA}$	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	SO-8 SO-8	190 130	°C/W °C/W
$\theta_{JC}$	Thermal Resistance (Junction-to-Case)	Standard Board	SO-8	41 to 44	°C/W
$\theta_{JA}$	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	TSSOP-8 TSSOP-8	185 140	°C/W °C/W
$\theta_{JC}$	Thermal Resistance (Junction-to-Case)	Standard Board	TSSOP-8	41 to 44	°C/W
T <sub>sol</sub>	Wave Solder Pb-Free	<2 to 3 sec @ 260°C		265	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### Table 4. PECL DC CHARACTERISTICS V<sub>CC</sub> = 3.3 V, GND = 0 V (Note 2)

			<b>−40°C</b>		25°C			85°C			
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I <sub>CCH</sub>	Power Supply Current (Outputs set to HIGH)	10	23	30	10	23	30	10	24	30	mA
I <sub>CCL</sub>	Power Supply Current (Outputs set to LOW)	15	26	35	15	26	35	15	27	35	mA
VIH	Input HIGH Voltage	2075		2420	2075		2420	2075		2420	mV
VIL	Input LOW Voltage	1355		1675	1355		1675	1355		1675	mV
V <sub>IHCMR</sub>	Input HIGH Voltage Common Mode Range (Note 3)	1.2		3.3	1.2		3.3	1.2		3.3	V
I <sub>IH</sub>	Input HIGH Current			150			150			150	μA
١ <sub>١L</sub>	Input LOW Current	-150			-150			-150			μA

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm.

2. All values vary 1:1 with  $V_{CC}$ . 3.  $V_{IHCMR}$  minimum varies 1:1 with  $V_{EE}$ ,  $V_{IHCMR}$  max varies 1:1 with  $V_{CC}$ . The  $V_{IHCMR}$  range is referenced to the most positive side of the differential input signal.

Table 5. TTL DC CHARACTERISTICS V<sub>CC</sub> = 3.3 V, GND = 0.0 V, T<sub>A</sub> =  $-40^{\circ}$ C to  $85^{\circ}$ C

Symbol	Characteristic Condition		Min	Тур	Max	Unit
V <sub>OH</sub>	Output HIGH Voltage	I <sub>OH</sub> = -3.0 mA	2.4			V
V <sub>OL</sub>	Output LOW Voltage	I <sub>OL</sub> = 24 mA			0.5	V
I <sub>OS</sub>	Output Short Circuit Current		-180		-50	mA

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm.

		<b>−40°C</b>		25°C			85°C				
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
f <sub>max</sub>	Maximum Frequency	160			160			160			MHz
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay to Output Differential (Note 5) $C_L = 20 \text{ pF}$	1.55	1.9	2.95	1.55	1.9	2.95	1.55	1.9	3.25	ns
t <sub>SK+ +</sub> t <sub>SK</sub> t <sub>SKPP</sub>	Output-to-Output Skew++ Output-to-Output Skew- – Part-to-Part Skew (Note 6)			60 25 500			60 25 500			60 25 500	ps
<b>t</b> JITTER	Random Clock Jitter (RMS)		6.0	20		6.0	20		6.0	20	ps
V <sub>PP</sub>	Input Voltage Swing (Differential Configuration)	150	800	1200	150	800	1200	150	800	1200	mV
t <sub>r</sub> t <sub>f</sub>	Output Rise/Fall Times C <sub>L</sub> = 20 pF (0.8 V to 2.0 V)	700 300	900	1700 1250	700 300	900	1700 1250	700 300	900	1700 1250	ps

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm.

4. Measured using a 750 mV source, 50% duty cycle clock source. All loading with 500  $\Omega$  to GND, CL = 20 pF.

5. Reference ( $V_{CC} = 3.3 \text{ V} \pm 5\%$ ; GND = 0 V). 6. Skews are measured between outputs under identical conditions.

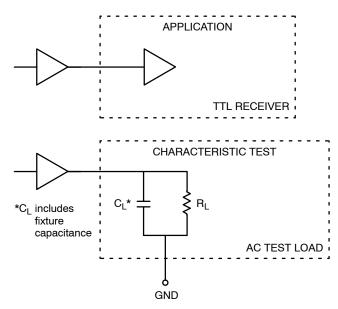


Figure 2. TTL Output Loading Used for Device Evaluation

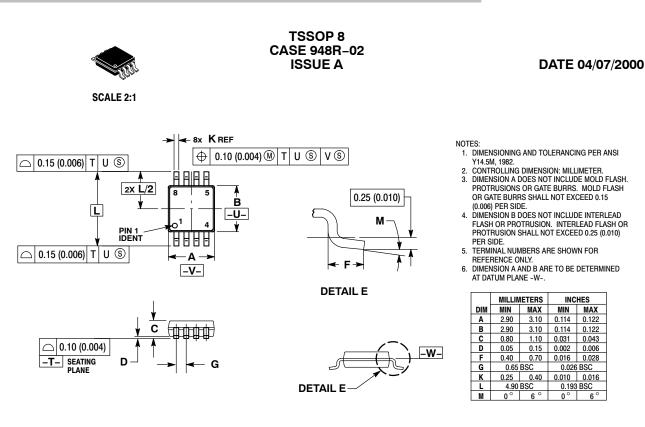
### **Resource Reference of Application Notes**

AN1405/D	-	ECL Clock Distribution Techniques
AN1406/D	-	Designing with PECL (ECL at +5.0 V)
AN1503/D	-	ECLinPS <sup>™</sup> I/O SPiCE Modeling Kit
AN1504/D	-	Metastability and the ECLinPS Family
AN1568/D	_	Interfacing Between LVDS and ECL
AN1672/D	_	The ECL Translator Guide
AND8001/D	_	Odd Number Counters Design
AND8002/D	-	Marking and Date Codes
AND8020/D	_	Termination of ECL Logic Devices

- AND8066/D Interfacing with ECLinPS
- AND8090/D AC Characteristics of ECL Devices

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